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Understanding Embedded - FPGAs (Field Programmable Gate Array)

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Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details

| | |
|--------------------------------|---|
| Product Status | Obsolete |
| Number of LABs/CLBs | 359200 |
| Number of Logic Elements/Cells | 952000 |
| Total RAM Bits | 53248000 |
| Number of I/O | 600 |
| Number of Gates | - |
| Voltage - Supply | 0.82V ~ 0.88V |
| Mounting Type | Surface Mount |
| Operating Temperature | 0°C ~ 85°C (TJ) |
| Package / Case | 1760-BBGA, FCBGA |
| Supplier Device Package | 1760-HBGA (45x45) |
| Purchase URL | https://www.e-xfl.com/product-detail/intel/5sgxmbr2h43c2ln |

Table 6. Recommended Operating Conditions for Stratix V Devices (Part 2 of 2)

| Symbol | Description | Condition | Min ⁽⁴⁾ | Typ | Max ⁽⁴⁾ | Unit |
|-------------------|------------------------|--------------|--------------------|-----|--------------------|------|
| t _{RAMP} | Power supply ramp time | Standard POR | 200 μ s | — | 100 ms | — |
| | | Fast POR | 200 μ s | — | 4 ms | — |

Notes to Table 6:

- (1) V_{CCPD} must be 2.5 V when V_{CCIO} is 2.5, 1.8, 1.5, 1.35, 1.25 or 1.2 V. V_{CCPD} must be 3.0 V when V_{CCIO} is 3.0 V.
- (2) If you do not use the design security feature in Stratix V devices, connect V_{CCBAT} to a 1.2- to 3.0-V power supply. Stratix V power-on-reset (POR) circuitry monitors V_{CCBAT}. Stratix V devices will not exit POR if V_{CCBAT} stays at logic low.
- (3) C2L and I2L can also be run at 0.90 V for legacy boards that were designed for the C2 and I2 speed grades.
- (4) The power supply value describes the budget for the DC (static) power supply tolerance and does not include the dynamic tolerance requirements. Refer to the PDN tool for the additional budget for the dynamic tolerance requirements.

Table 7 lists the transceiver power supply recommended operating conditions for Stratix V GX, GS, and GT devices.

Table 7. Recommended Transceiver Power Supply Operating Conditions for Stratix V GX, GS, and GT Devices (Part 1 of 2)

| Symbol | Description | Devices | Minimum ⁽⁴⁾ | Typical | Maximum ⁽⁴⁾ | Unit |
|-----------------------------------|---|------------|------------------------|---------|------------------------|------|
| V _{CCA_GXBL} (1), (3) | Transceiver channel PLL power supply (left side) | GX, GS, GT | 2.85 | 3.0 | 3.15 | V |
| | | | 2.375 | 2.5 | 2.625 | |
| V _{CCA_GXBR} (1), (3) | Transceiver channel PLL power supply (right side) | GX, GS | 2.85 | 3.0 | 3.15 | V |
| | | | 2.375 | 2.5 | 2.625 | |
| V _{CCA_GTBR} | Transceiver channel PLL power supply (right side) | GT | 2.85 | 3.0 | 3.15 | V |
| V _{CCHIP_L} | Transceiver hard IP power supply (left side; C1, C2, I2, and I3YY speed grades) | GX, GS, GT | 0.87 | 0.9 | 0.93 | V |
| | Transceiver hard IP power supply (left side; C2L, C3, C4, I2L, I3, I3L, and I4 speed grades) | GX, GS, GT | 0.82 | 0.85 | 0.88 | V |
| V _{CCHIP_R} | Transceiver hard IP power supply (right side; C1, C2, I2, and I3YY speed grades) | GX, GS, GT | 0.87 | 0.9 | 0.93 | V |
| | Transceiver hard IP power supply (right side; C2L, C3, C4, I2L, I3, I3L, and I4 speed grades) | GX, GS, GT | 0.82 | 0.85 | 0.88 | V |
| V _{CCHSSI_L} | Transceiver PCS power supply (left side; C1, C2, I2, and I3YY speed grades) | GX, GS, GT | 0.87 | 0.9 | 0.93 | V |
| | Transceiver PCS power supply (left side; C2L, C3, C4, I2L, I3, I3L, and I4 speed grades) | GX, GS, GT | 0.82 | 0.85 | 0.88 | V |
| V _{CCHSSI_R} | Transceiver PCS power supply (right side; C1, C2, I2, and I3YY speed grades) | GX, GS, GT | 0.87 | 0.9 | 0.93 | V |
| | Transceiver PCS power supply (right side; C2L, C3, C4, I2L, I3, I3L, and I4 speed grades) | GX, GS, GT | 0.82 | 0.85 | 0.88 | V |
| V _{CCR_GXBL} (2) | Receiver analog power supply (left side) | GX, GS, GT | 0.82 | 0.85 | 0.88 | V |
| | | | 0.87 | 0.90 | 0.93 | |
| | | | 0.97 | 1.0 | 1.03 | |
| | | | 1.03 | 1.05 | 1.07 | |

Table 7. Recommended Transceiver Power Supply Operating Conditions for Stratix V GX, GS, and GT Devices (Part 2 of 2)

| Symbol | Description | Devices | Minimum ⁽⁴⁾ | Typical | Maximum ⁽⁴⁾ | Unit |
|------------------------|--|------------|------------------------|---------|------------------------|------|
| V_{CCR_GXBR} (2) | Receiver analog power supply (right side) | GX, GS, GT | 0.82 | 0.85 | 0.88 | V |
| | | | 0.87 | 0.90 | 0.93 | |
| | | | 0.97 | 1.0 | 1.03 | |
| | | | 1.03 | 1.05 | 1.07 | |
| V_{CCR_GTBR} | Receiver analog power supply for GT channels (right side) | GT | 1.02 | 1.05 | 1.08 | V |
| V_{CCT_GXBL} (2) | Transmitter analog power supply (left side) | GX, GS, GT | 0.82 | 0.85 | 0.88 | V |
| | | | 0.87 | 0.90 | 0.93 | |
| | | | 0.97 | 1.0 | 1.03 | |
| | | | 1.03 | 1.05 | 1.07 | |
| V_{CCT_GXBR} (2) | Transmitter analog power supply (right side) | GX, GS, GT | 0.82 | 0.85 | 0.88 | V |
| | | | 0.87 | 0.90 | 0.93 | |
| | | | 0.97 | 1.0 | 1.03 | |
| | | | 1.03 | 1.05 | 1.07 | |
| V_{CCT_GTBR} | Transmitter analog power supply for GT channels (right side) | GT | 1.02 | 1.05 | 1.08 | V |
| V_{CCL_GTBR} | Transmitter clock network power supply | GT | 1.02 | 1.05 | 1.08 | V |
| V_{CCH_GXBL} | Transmitter output buffer power supply (left side) | GX, GS, GT | 1.425 | 1.5 | 1.575 | V |
| V_{CCH_GXBR} | Transmitter output buffer power supply (right side) | GX, GS, GT | 1.425 | 1.5 | 1.575 | V |

Notes to Table 7:

- (1) This supply must be connected to 3.0 V if the CMU PLL, receiver CDR, or both, are configured at a base data rate > 6.5 Gbps. Up to 6.5 Gbps, you can connect this supply to either 3.0 V or 2.5 V.
- (2) Refer to Table 8 to select the correct power supply level for your design.
- (3) When using ATX PLLs, the supply must be 3.0 V.
- (4) This value describes the budget for the DC (static) power supply tolerance and does not include the dynamic tolerance requirements. Refer to the PDN tool for the additional budget for the dynamic tolerance requirements.

Table 8 shows the transceiver power supply voltage requirements for various conditions.

Table 8. Transceiver Power Supply Voltage Requirements

| Conditions | Core Speed Grade | VCCR_GXB & VCCT_GXB ⁽²⁾ | VCCA_GXB | VCCH_GXB | Unit |
|---|-----------------------------------|------------------------------------|----------|----------|------|
| If BOTH of the following conditions are true: <ul style="list-style-type: none"> ■ Data rate > 10.3 Gbps. ■ DFE is used. | All | 1.05 | 3.0 | 1.5 | V |
| If ANY of the following conditions are true ⁽¹⁾ : <ul style="list-style-type: none"> ■ ATX PLL is used. ■ Data rate > 6.5Gbps. ■ DFE (data rate ≤ 10.3 Gbps), AEQ, or EyeQ feature is used. | All | 1.0 | | | |
| If ALL of the following conditions are true: <ul style="list-style-type: none"> ■ ATX PLL is not used. ■ Data rate ≤ 6.5Gbps. ■ DFE, AEQ, and EyeQ are not used. | C1, C2, I2, and I3YY | 0.90 | 2.5 | | |
| | C2L, C3, C4, I2L, I3, I3L, and I4 | 0.85 | 2.5 | | |

Notes to Table 8:

- (1) Choose this power supply voltage requirement option if you plan to upgrade your design later with any of the listed conditions.
- (2) If the VCCR_GXB and VCCT_GXB supplies are set to 1.0 V or 1.05 V, they cannot be shared with the VCC core supply. If the VCCR_GXB and VCCT_GXB are set to either 0.90 V or 0.85 V, they can be shared with the VCC core supply.

DC Characteristics

This section lists the supply current, I/O pin leakage current, input pin capacitance, on-chip termination tolerance, and hot socketing specifications.

Supply Current

Supply current is the current drawn from the respective power rails used for power budgeting. Use the Excel-based Early Power Estimator (EPE) to get supply current estimates for your design because these currents vary greatly with the resources you use.



For more information about power estimation tools, refer to the *PowerPlay Early Power Estimator User Guide* and the *PowerPlay Power Analysis* chapter in the *Quartus II Handbook*.

Table 13. OCT Variation after Power-Up Calibration for Stratix V Devices (Part 2 of 2) ⁽¹⁾

| Symbol | Description | V _{CCIO} (V) | Typical | Unit |
|--------|--|-----------------------|---------|-------------------|
| dR/dT | OCT variation with temperature without recalibration | 3.0 | 0.189 | %/ ^o C |
| | | 2.5 | 0.208 | |
| | | 1.8 | 0.266 | |
| | | 1.5 | 0.273 | |
| | | 1.2 | 0.317 | |

Note to Table 13:

(1) Valid for a V_{CCIO} range of $\pm 5\%$ and a temperature range of 0° to 85°C.

Pin Capacitance

Table 14 lists the Stratix V device family pin capacitance.

Table 14. Pin Capacitance for Stratix V Devices

| Symbol | Description | Value | Unit |
|--------------------|--|-------|------|
| C _{IOTB} | Input capacitance on the top and bottom I/O pins | 6 | pF |
| C _{IOLR} | Input capacitance on the left and right I/O pins | 6 | pF |
| C _{OUTFB} | Input capacitance on dual-purpose clock output and feedback pins | 6 | pF |

Hot Socketing

Table 15 lists the hot socketing specifications for Stratix V devices.

Table 15. Hot Socketing Specifications for Stratix V Devices

| Symbol | Description | Maximum |
|---------------------------|--|---------------------|
| I _{IOPIN} (DC) | DC current per I/O pin | 300 μ A |
| I _{IOPIN} (AC) | AC current per I/O pin | 8 mA ⁽¹⁾ |
| I _{XCVR-TX} (DC) | DC current per transceiver transmitter pin | 100 mA |
| I _{XCVR-RX} (DC) | DC current per transceiver receiver pin | 50 mA |

Note to Table 15:

(1) The I/O ramp rate is 10 ns or more. For ramp rates faster than 10 ns, $|I_{IOPIN}| = C \, dv/dt$, in which C is the I/O pin capacitance and dv/dt is the slew rate.

Table 21. Differential HSTL and HSUL I/O Standards for Stratix V Devices (Part 2 of 2)

| I/O Standard | V_{CCIO} (V) | | | $V_{DIF(DC)}$ (V) | | $V_{X(AC)}$ (V) | | | $V_{CM(DC)}$ (V) | | | $V_{DIF(AC)}$ (V) | |
|---------------------|----------------|-----|------|-------------------|------------------|-------------------------|------------------|-------------------------|------------------|------------------|------------------|-------------------|-------------------|
| | Min | Typ | Max | Min | Max | Min | Typ | Max | Min | Typ | Max | Min | Max |
| HSTL-12 Class I, II | 1.14 | 1.2 | 1.26 | 0.16 | $V_{CCIO} + 0.3$ | — | $0.5^* V_{CCIO}$ | — | $0.4^* V_{CCIO}$ | $0.5^* V_{CCIO}$ | $0.6^* V_{CCIO}$ | 0.3 | $V_{CCIO} + 0.48$ |
| HSUL-12 | 1.14 | 1.2 | 1.3 | 0.26 | 0.26 | $0.5^* V_{CCIO} - 0.12$ | $0.5^* V_{CCIO}$ | $0.5^* V_{CCIO} + 0.12$ | $0.4^* V_{CCIO}$ | $0.5^* V_{CCIO}$ | $0.6^* V_{CCIO}$ | 0.44 | 0.44 |

Table 22. Differential I/O Standard Specifications for Stratix V Devices ⁽⁷⁾

| I/O Standard | V_{CCIO} (V) ⁽¹⁰⁾ | | | V_{ID} (mV) ⁽⁸⁾ | | | $V_{ICM(DC)}$ (V) | | | V_{OD} (V) ⁽⁶⁾ | | | V_{OCM} (V) ⁽⁶⁾ | | |
|--------------------------------|--|-----|-------|------------------------------|-------------------|-----|-------------------|-------------------------|-------|-----------------------------|-----|-----|------------------------------|------|-------|
| | Min | Typ | Max | Min | Condition | Max | Min | Condition | Max | Min | Typ | Max | Min | Typ | Max |
| PCML | Transmitter, receiver, and input reference clock pins of the high-speed transceivers use the PCML I/O standard. For transmitter, receiver, and reference clock I/O pin specifications, refer to Table 23 on page 18. | | | | | | | | | | | | | | |
| 2.5 V LVDS ⁽¹⁾ | 2.375 | 2.5 | 2.625 | 100 | $V_{CM} = 1.25$ V | — | 0.05 | $D_{MAX} \leq 700$ Mbps | 1.8 | 0.247 | — | 0.6 | 1.125 | 1.25 | 1.375 |
| | | | | | | — | 1.05 | $D_{MAX} > 700$ Mbps | 1.55 | 0.247 | — | 0.6 | 1.125 | 1.25 | 1.375 |
| BLVDS ⁽⁵⁾ | 2.375 | 2.5 | 2.625 | 100 | — | — | — | — | — | — | — | — | — | — | — |
| RSDS (HIO) ⁽²⁾ | 2.375 | 2.5 | 2.625 | 100 | $V_{CM} = 1.25$ V | — | 0.3 | — | 1.4 | 0.1 | 0.2 | 0.6 | 0.5 | 1.2 | 1.4 |
| Mini-LVDS (HIO) ⁽³⁾ | 2.375 | 2.5 | 2.625 | 200 | — | 600 | 0.4 | — | 1.325 | 0.25 | — | 0.6 | 1 | 1.2 | 1.4 |
| LVPECL ^{(4), (9)} | — | — | — | 300 | — | — | 0.6 | $D_{MAX} \leq 700$ Mbps | 1.8 | — | — | — | — | — | — |
| | — | — | — | 300 | — | — | 1 | $D_{MAX} > 700$ Mbps | 1.6 | — | — | — | — | — | — |

Notes to Table 22:

- (1) For optimized LVDS receiver performance, the receiver voltage input range must be between 1.0 V to 1.6 V for data rates above 700 Mbps, and 0 V to 1.85 V for data rates below 700 Mbps.
- (2) For optimized RSDS receiver performance, the receiver voltage input range must be between 0.25 V to 1.45 V.
- (3) For optimized Mini-LVDS receiver performance, the receiver voltage input range must be between 0.3 V to 1.425 V.
- (4) For optimized LVPECL receiver performance, the receiver voltage input range must be between 0.85 V to 1.75 V for data rate above 700 Mbps and 0.45 V to 1.95 V for data rate below 700 Mbps.
- (5) There are no fixed V_{ICM} , V_{OD} , and V_{OCM} specifications for BLVDS. They depend on the system topology.
- (6) RL range: $90 \leq RL \leq 110 \Omega$.
- (7) The 1.4-V and 1.5-V PCML transceiver I/O standard specifications are described in "Transceiver Performance Specifications" on page 18.
- (8) The minimum VID value is applicable over the entire common mode range, VCM.
- (9) LVPECL is only supported on dedicated clock input pins.
- (10) Differential inputs are powered by VCCPD which requires 2.5 V.

Power Consumption

Altera offers two ways to estimate power consumption for a design—the Excel-based Early Power Estimator and the Quartus® II PowerPlay Power Analyzer feature.

Switching Characteristics

This section provides performance characteristics of the Stratix V core and periphery blocks.

These characteristics can be designated as Preliminary or Final.

- Preliminary characteristics are created using simulation results, process data, and other known parameters. The title of these tables show the designation as “Preliminary.”
- Final numbers are based on actual silicon characterization and testing. The numbers reflect the actual performance of the device under worst-case silicon process, voltage, and junction temperature conditions. There are no designations on finalized tables.

Transceiver Performance Specifications

This section describes transceiver performance specifications.

Table 23 lists the Stratix V GX and GS transceiver specifications.

Table 23. Transceiver Specifications for Stratix V GX and GS Devices ⁽¹⁾ (Part 1 of 7)

| Symbol/ Description | Conditions | Transceiver Speed Grade 1 | | | Transceiver Speed Grade 2 | | | Transceiver Speed Grade 3 | | | Unit |
|--|---|---|-----|-----|------------------------------|-----|-----|------------------------------|-----|-----|------|
| | | Min | Typ | Max | Min | Typ | Max | Min | Typ | Max | |
| Reference Clock | | | | | | | | | | | |
| Supported I/O Standards | Dedicated reference clock pin | 1.2-V PCML, 1.4-V PCML, 1.5-V PCML, 2.5-V PCML, Differential LVPECL, LVDS, and HCSL | | | | | | | | | |
| | RX reference clock pin | 1.4-V PCML, 1.5-V PCML, 2.5-V PCML, LVPECL, and LVDS | | | | | | | | | |
| Input Reference Clock Frequency (CMU PLL) ⁽⁸⁾ | — | 40 | — | 710 | 40 | — | 710 | 40 | — | 710 | MHz |
| Input Reference Clock Frequency (ATX PLL) ⁽⁸⁾ | — | 100 | — | 710 | 100 | — | 710 | 100 | — | 710 | MHz |
| Rise time | Measure at ±60 mV of differential signal ⁽²⁶⁾ | — | — | 400 | — | — | 400 | — | — | 400 | ps |
| Fall time | Measure at ±60 mV of differential signal ⁽²⁶⁾ | — | — | 400 | — | — | 400 | — | — | 400 | |
| Duty cycle | — | 45 | — | 55 | 45 | — | 55 | 45 | — | 55 | % |
| Spread-spectrum modulating clock frequency | PCI Express® (PCIe®) | 30 | — | 33 | 30 | — | 33 | 30 | — | 33 | kHz |

Table 23. Transceiver Specifications for Stratix V GX and GS Devices ⁽¹⁾ (Part 7 of 7)

| Symbol/ Description | Conditions | Transceiver Speed Grade 1 | | | Transceiver Speed Grade 2 | | | Transceiver Speed Grade 3 | | | Unit |
|------------------------|------------|------------------------------|-----|-----|------------------------------|-----|-----|------------------------------|-----|-----|------|
| | | Min | Typ | Max | Min | Typ | Max | Min | Typ | Max | |
| $t_{pll_lock}^{(16)}$ | — | — | — | 10 | — | — | 10 | — | — | 10 | μs |

Notes to Table 23:

- (1) Speed grades shown in Table 23 refer to the PMA Speed Grade in the device ordering code. The maximum data rate could be restricted by the Core/PCS speed grade. Contact your Altera Sales Representative for the maximum data rate specifications in each speed grade combination offered. For more information about device ordering codes, refer to the *Stratix V Device Overview*.
- (2) The reference clock common mode voltage is equal to the V_{CCR_GXB} power supply level.
- (3) This supply must be connected to 1.0 V if the transceiver is configured at a data rate > 6.5 Gbps, and to 1.05 V if configured at a data rate > 10.3 Gbps when DFE is used. For data rates up to 6.5 Gbps, you can connect this supply to 0.85 V.
- (4) This supply follows V_{CCR_GXB} .
- (5) The device cannot tolerate prolonged operation at this absolute maximum.
- (6) The differential eye opening specification at the receiver input pins assumes that **Receiver Equalization** is disabled. If you enable **Receiver Equalization**, the receiver circuitry can tolerate a lower minimum eye opening, depending on the equalization level.
- (7) The Quartus II software automatically selects the appropriate slew rate depending on the configured data rate or functional mode.
- (8) The input reference clock frequency options depend on the data rate and the device speed grade.
- (9) The line data rate may be limited by PCS-FPGA interface speed grade.
- (10) Refer to Figure 1 for the GX channel AC gain curves. The total effective AC gain is the AC gain minus the DC gain.
- (11) t_{LTR} is the time required for the receive CDR to lock to the input reference clock frequency after coming out of reset.
- (12) t_{LTD} is time required for the receiver CDR to start recovering valid data after the rx_is_lockedtodata signal goes high.
- (13) t_{LTD_manual} is the time required for the receiver CDR to start recovering valid data after the rx_is_lockedtodata signal goes high when the CDR is functioning in the manual mode.
- (14) $t_{LTR_LTD_manual}$ is the time the receiver CDR must be kept in lock to reference (LTR) mode after the rx_is_lockedtoref signal goes high when the CDR is functioning in the manual mode.
- (15) $t_{pll_powerdown}$ is the PLL powerdown minimum pulse width.
- (16) t_{pll_lock} is the time required for the transmitter CMU/ATX PLL to lock to the input reference clock frequency after coming out of reset.
- (17) To calculate the REFCLK rms phase jitter requirement for PCIe at reference clock frequencies other than 100 MHz, use the following formula: REFCLK rms phase jitter at f(MHz) = REFCLK rms phase jitter at 100 MHz \times 100/f.
- (18) The maximum peak to peak differential input voltage V_{ID} after device configuration is equal to $4 \times (\text{absolute } V_{MAX} \text{ for receiver pin} - V_{ICM})$.
- (19) For ES devices, R_{REF} is $2000 \Omega \pm 1\%$.
- (20) To calculate the REFCLK phase noise requirement at frequencies other than 622 MHz, use the following formula: REFCLK phase noise at f(MHz) = REFCLK phase noise at 622 MHz + $20 \times \log(f/622)$.
- (21) SFP/+ optical modules require the host interface to have RD+/- differentially terminated with 100Ω . The internal OCT feature is available after the Stratix V FPGA configuration is completed. Altera recommends that FPGA configuration is completed before inserting the optical module. Otherwise, minimize unnecessary removal and insertion with unconfigured devices.
- (22) Refer to Figure 2.
- (23) For oversampling designs to support data rates less than the minimum specification, the CDR needs to be in LTR mode only.
- (24) I3YY devices can achieve data rates up to 10.3125 Gbps.
- (25) When you use fPLL as a TXPLL of the transceiver.
- (26) REFCLK performance requires to meet transmitter REFCLK phase noise specification.
- (27) Minimum eye opening of 85 mV is only for the unstressed input eye condition.

Table 26 shows the approximate maximum data rate using the 10G PCS.

Table 26. Stratix V 10G PCS Approximate Maximum Data Rate ⁽¹⁾

| Mode ⁽²⁾ | Transceiver Speed Grade | PMA Width | 64 | 40 | 40 | 40 | 32 | 32 |
|---------------------|-------------------------|---------------------------------------|--------------|-------|-------|------|----------|-------|
| | | PCS Width | 64 | 66/67 | 50 | 40 | 64/66/67 | 32 |
| FIFO or Register | 1 | C1, C2, C2L, I2, I2L core speed grade | 14.1 | 14.1 | 10.69 | 14.1 | 13.6 | 13.6 |
| | 2 | C1, C2, C2L, I2, I2L core speed grade | 12.5 | 12.5 | 10.69 | 12.5 | 12.5 | 12.5 |
| | | C3, I3, I3L core speed grade | 12.5 | 12.5 | 10.69 | 12.5 | 10.88 | 10.88 |
| | 3 | C1, C2, C2L, I2, I2L core speed grade | 8.5 Gbps | | | | | |
| | | C3, I3, I3L core speed grade | | | | | | |
| | | C4, I4 core speed grade | | | | | | |
| | | I3YY core speed grade | 10.3125 Gbps | | | | | |

Notes to Table 26:

- (1) The maximum data rate is in Gbps.
- (2) The Phase Compensation FIFO can be configured in FIFO mode or register mode. In the FIFO mode, the pointers are not fixed, and the latency can vary. In the register mode the pointers are fixed for low latency.

Table 28. Transceiver Specifications for Stratix V GT Devices (Part 4 of 5) ⁽¹⁾

| Symbol/ Description | Conditions | Transceiver Speed Grade 2 | | | Transceiver Speed Grade 3 | | | Unit |
|--|--|------------------------------|-----|--------------------------------|------------------------------|-----|--------------------------------|------|
| | | Min | Typ | Max | Min | Typ | Max | |
| Data rate | GT channels | 19,600 | — | 28,050 | 19,600 | — | 25,780 | Mbps |
| Differential on-chip termination resistors | GT channels | — | 100 | — | — | 100 | — | Ω |
| | GX channels | (8) | | | | | | |
| V _{OCM} (AC coupled) | GT channels | — | 500 | — | — | 500 | — | mV |
| | GX channels | (8) | | | | | | |
| Rise/Fall time | GT channels | — | 15 | — | — | 15 | — | ps |
| | GX channels | (8) | | | | | | |
| Intra-differential pair skew | GX channels | (8) | | | | | | |
| Intra-transceiver block transmitter channel-to- channel skew | GX channels | (8) | | | | | | |
| Inter-transceiver block transmitter channel-to- channel skew | GX channels | (8) | | | | | | |
| CMU PLL | | | | | | | | |
| Supported Data Range | — | 600 | — | 12500 | 600 | — | 8500 | Mbps |
| t _{pll_powerdown} ⁽¹³⁾ | — | 1 | — | — | 1 | — | — | μs |
| t _{pll_lock} ⁽¹⁴⁾ | — | — | — | 10 | — | — | 10 | μs |
| ATX PLL | | | | | | | | |
| Supported Data Rate Range for GX Channels | VCO post- divider L=2 | 8000 | — | 12500 | 8000 | — | 8500 | Mbps |
| | L=4 | 4000 | — | 6600 | 4000 | — | 6600 | Mbps |
| | L=8 | 2000 | — | 3300 | 2000 | — | 3300 | Mbps |
| | L=8, Local/Central Clock Divider =2 | 1000 | — | 1762.5 | 1000 | — | 1762.5 | Mbps |
| Supported Data Rate Range for GT Channels | VCO post- divider L=2 | 9800 | — | 14025 | 9800 | — | 12890 | Mbps |
| t _{pll_powerdown} ⁽¹³⁾ | — | 1 | — | — | 1 | — | — | μs |
| t _{pll_lock} ⁽¹⁴⁾ | — | — | — | 10 | — | — | 10 | μs |
| fPLL | | | | | | | | |
| Supported Data Range | — | 600 | — | 3250/ 3.125 ⁽²³⁾ | 600 | — | 3250/ 3.125 ⁽²³⁾ | Mbps |
| t _{pll_powerdown} ⁽¹³⁾ | — | 1 | — | — | 1 | — | — | μs |

Table 31. PLL Specifications for Stratix V Devices (Part 2 of 3)

| Symbol | Parameter | Min | Typ | Max | Unit |
|--|--|------|---------|--|-----------|
| t_{INCCJ} ^{(3), (4)} | Input clock cycle-to-cycle jitter ($f_{\text{REF}} \geq 100$ MHz) | — | — | 0.15 | UI (p-p) |
| | Input clock cycle-to-cycle jitter ($f_{\text{REF}} < 100$ MHz) | −750 | — | +750 | ps (p-p) |
| $t_{\text{OUTPJ_DC}}$ ⁽⁵⁾ | Period Jitter for dedicated clock output ($f_{\text{OUT}} \geq 100$ MHz) | — | — | 175 ⁽¹⁾ | ps (p-p) |
| | Period Jitter for dedicated clock output ($f_{\text{OUT}} < 100$ MHz) | — | — | 17.5 ⁽¹⁾ | mUI (p-p) |
| $t_{\text{FOUTPJ_DC}}$ ⁽⁵⁾ | Period Jitter for dedicated clock output in fractional PLL ($f_{\text{OUT}} \geq 100$ MHz) | — | — | 250 ⁽¹¹⁾ , 175 ⁽¹²⁾ | ps (p-p) |
| | Period Jitter for dedicated clock output in fractional PLL ($f_{\text{OUT}} < 100$ MHz) | — | — | 25 ⁽¹¹⁾ , 17.5 ⁽¹²⁾ | mUI (p-p) |
| $t_{\text{OUTCCJ_DC}}$ ⁽⁵⁾ | Cycle-to-Cycle Jitter for a dedicated clock output ($f_{\text{OUT}} \geq 100$ MHz) | — | — | 175 | ps (p-p) |
| | Cycle-to-Cycle Jitter for a dedicated clock output ($f_{\text{OUT}} < 100$ MHz) | — | — | 17.5 | mUI (p-p) |
| $t_{\text{FOUTCCJ_DC}}$ ⁽⁵⁾ | Cycle-to-cycle Jitter for a dedicated clock output in fractional PLL ($f_{\text{OUT}} \geq 100$ MHz) | — | — | 250 ⁽¹¹⁾ , 175 ⁽¹²⁾ | ps (p-p) |
| | Cycle-to-cycle Jitter for a dedicated clock output in fractional PLL ($f_{\text{OUT}} < 100$ MHz)+ | — | — | 25 ⁽¹¹⁾ , 17.5 ⁽¹²⁾ | mUI (p-p) |
| $t_{\text{OUTPJ_IO}}$ ^{(5), (8)} | Period Jitter for a clock output on a regular I/O in integer PLL ($f_{\text{OUT}} \geq 100$ MHz) | — | — | 600 | ps (p-p) |
| | Period Jitter for a clock output on a regular I/O ($f_{\text{OUT}} < 100$ MHz) | — | — | 60 | mUI (p-p) |
| $t_{\text{FOUTPJ_IO}}$ ^{(5), (8), (11)} | Period Jitter for a clock output on a regular I/O in fractional PLL ($f_{\text{OUT}} \geq 100$ MHz) | — | — | 600 ⁽¹⁰⁾ | ps (p-p) |
| | Period Jitter for a clock output on a regular I/O in fractional PLL ($f_{\text{OUT}} < 100$ MHz) | — | — | 60 ⁽¹⁰⁾ | mUI (p-p) |
| $t_{\text{OUTCCJ_IO}}$ ^{(5), (8)} | Cycle-to-cycle Jitter for a clock output on a regular I/O in integer PLL ($f_{\text{OUT}} \geq 100$ MHz) | — | — | 600 | ps (p-p) |
| | Cycle-to-cycle Jitter for a clock output on a regular I/O in integer PLL ($f_{\text{OUT}} < 100$ MHz) | — | — | 60 ⁽¹⁰⁾ | mUI (p-p) |
| $t_{\text{FOUTCCJ_IO}}$ ^{(5), (8), (11)} | Cycle-to-cycle Jitter for a clock output on a regular I/O in fractional PLL ($f_{\text{OUT}} \geq 100$ MHz) | — | — | 600 ⁽¹⁰⁾ | ps (p-p) |
| | Cycle-to-cycle Jitter for a clock output on a regular I/O in fractional PLL ($f_{\text{OUT}} < 100$ MHz) | — | — | 60 | mUI (p-p) |
| $t_{\text{CASC_OUTPJ_DC}}$ ^{(5), (6)} | Period Jitter for a dedicated clock output in cascaded PLLs ($f_{\text{OUT}} \geq 100$ MHz) | — | — | 175 | ps (p-p) |
| | Period Jitter for a dedicated clock output in cascaded PLLs ($f_{\text{OUT}} < 100$ MHz) | — | — | 17.5 | mUI (p-p) |
| f_{DRIFT} | Frequency drift after PFDENA is disabled for a duration of 100 μ s | — | — | ± 10 | % |
| dK_{BIT} | Bit number of Delta Sigma Modulator (DSM) | 8 | 24 | 32 | Bits |
| K_{VALUE} | Numerator of Fraction | 128 | 8388608 | 2147483648 | — |

Figure 7 shows the dynamic phase alignment (DPA) lock time specifications with the DPA PLL calibration option enabled.

Figure 7. DPA Lock Time Specification with DPA PLL Calibration Enabled

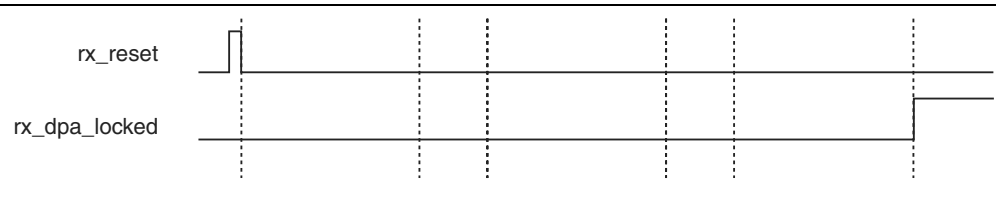


Table 37 lists the DPA lock time specifications for Stratix V devices.

Table 37. DPA Lock Time Specifications for Stratix V GX Devices Only ^{(1), (2), (3)}

| Standard | Training Pattern | Number of Data Transitions in One Repetition of the Training Pattern | Number of Repetitions per 256 Data Transitions ⁽⁴⁾ | Maximum |
|--------------------|----------------------|--|---|----------------------|
| SPI-4 | 00000000001111111111 | 2 | 128 | 640 data transitions |
| Parallel Rapid I/O | 00001111 | 2 | 128 | 640 data transitions |
| | 10010000 | 4 | 64 | 640 data transitions |
| Miscellaneous | 10101010 | 8 | 32 | 640 data transitions |
| | 01010101 | 8 | 32 | 640 data transitions |

Notes to Table 37:

- (1) The DPA lock time is for one channel.
- (2) One data transition is defined as a 0-to-1 or 1-to-0 transition.
- (3) The DPA lock time stated in this table applies to both commercial and industrial grade.
- (4) This is the number of repetitions for the stated training pattern to achieve the 256 data transitions.

Figure 8 shows the LVDS soft-clock data recovery (CDR)/DPA sinusoidal jitter tolerance specification for a data rate ≥ 1.25 Gbps. Table 38 lists the LVDS soft-CDR/DPA sinusoidal jitter tolerance specification for a data rate ≥ 1.25 Gbps.

Figure 8. LVDS Soft-CDR/DPA Sinusoidal Jitter Tolerance Specification for a Data Rate ≥ 1.25 Gbps

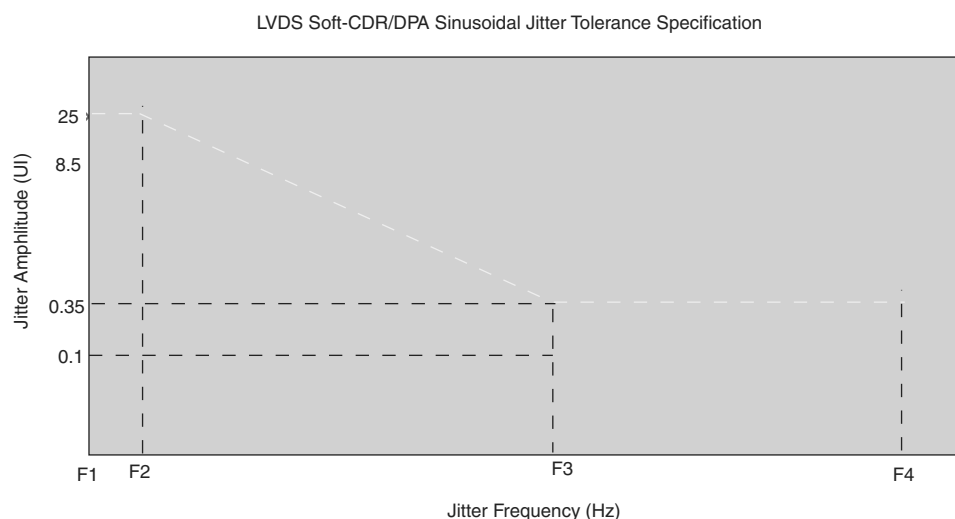


Table 40. DQS Phase Offset Delay Per Setting for Stratix V Devices ^{(1), (2)} (Part 2 of 2)

| Speed Grade | Min | Max | Unit |
|-------------|-----|-----|------|
| C4,I4 | 8 | 16 | ps |

Notes to Table 40:

- (1) The typical value equals the average of the minimum and maximum values.
- (2) The delay settings are linear with a cumulative delay variation of 40 ps for all speed grades. For example, when using a –2 speed grade and applying a 10-phase offset setting to a 90° phase shift at 400 MHz, the expected average cumulative delay is $[625 \text{ ps} + (10 \times 10 \text{ ps}) \pm 20 \text{ ps}] = 725 \text{ ps} \pm 20 \text{ ps}$.

Table 41 lists the DQS phase shift error for Stratix V devices.

Table 41. DQS Phase Shift Error Specification for DLL-Delayed Clock ($t_{\text{DQS_PSERR}}$) for Stratix V Devices ⁽¹⁾

| Number of DQS Delay Buffers | C1 | C2, C2L, I2, I2L | C3, I3, I3L, I3YY | C4,I4 | Unit |
|-----------------------------|-----|------------------|-------------------|-------|------|
| 1 | 28 | 28 | 30 | 32 | ps |
| 2 | 56 | 56 | 60 | 64 | ps |
| 3 | 84 | 84 | 90 | 96 | ps |
| 4 | 112 | 112 | 120 | 128 | ps |

Notes to Table 41:

- (1) This error specification is the absolute maximum and minimum error. For example, skew on three DQS delay buffers in a –2 speed grade is $\pm 78 \text{ ps}$ or $\pm 39 \text{ ps}$.

Table 42 lists the memory output clock jitter specifications for Stratix V devices.

Table 42. Memory Output Clock Jitter Specification for Stratix V Devices ^{(1), (Part 1 of 2)} ^{(2), (3)}

| Clock Network | Parameter | Symbol | C1 | | C2, C2L, I2, I2L | | C3, I3, I3L, I3YY | | C4,I4 | | Unit |
|---------------|------------------------------|------------------------|------|-----|------------------|-----|-------------------|------|-------|------|------|
| | | | Min | Max | Min | Max | Min | Max | Min | Max | |
| Regional | Clock period jitter | $t_{\text{JIT(per)}}$ | –50 | 50 | –50 | 50 | –55 | 55 | –55 | 55 | ps |
| | Cycle-to-cycle period jitter | $t_{\text{JIT(cc)}}$ | –100 | 100 | –100 | 100 | –110 | 110 | –110 | 110 | ps |
| | Duty cycle jitter | $t_{\text{JIT(duty)}}$ | –50 | 50 | –50 | 50 | –82.5 | 82.5 | –82.5 | 82.5 | ps |
| Global | Clock period jitter | $t_{\text{JIT(per)}}$ | –75 | 75 | –75 | 75 | –82.5 | 82.5 | –82.5 | 82.5 | ps |
| | Cycle-to-cycle period jitter | $t_{\text{JIT(cc)}}$ | –150 | 150 | –150 | 150 | –165 | 165 | –165 | 165 | ps |
| | Duty cycle jitter | $t_{\text{JIT(duty)}}$ | –75 | 75 | –75 | 75 | –90 | 90 | –90 | 90 | ps |

Table 42. Memory Output Clock Jitter Specification for Stratix V Devices ⁽¹⁾, (Part 2 of 2) ⁽²⁾, ⁽³⁾

| Clock Network | Parameter | Symbol | C1 | | C2, C2L, I2, I2L | | C3, I3, I3L, I3YY | | C4,I4 | | Unit |
|---------------|------------------------------|-----------------|-------|------|------------------|------|-------------------|-----|-------|-----|------|
| | | | Min | Max | Min | Max | Min | Max | Min | Max | |
| PHY Clock | Clock period jitter | $t_{JIT(per)}$ | -25 | 25 | -25 | 25 | -30 | 30 | -35 | 35 | ps |
| | Cycle-to-cycle period jitter | $t_{JIT(cc)}$ | -50 | 50 | -50 | 50 | -60 | 60 | -70 | 70 | ps |
| | Duty cycle jitter | $t_{JIT(duty)}$ | -37.5 | 37.5 | -37.5 | 37.5 | -45 | 45 | -56 | 56 | ps |

Notes to Table 42:

- (1) The clock jitter specification applies to the memory output clock pins generated using differential signal-splitter and DDIO circuits clocked by a PLL output routed on a PHY, regional, or global clock network as specified. Altera recommends using PHY clock networks whenever possible.
- (2) The clock jitter specification applies to the memory output clock pins clocked by an integer PLL.
- (3) The memory output clock jitter is applicable when an input jitter of 30 ps peak-to-peak is applied with bit error rate (BER) -12, equivalent to 14 sigma.

OCT Calibration Block Specifications

Table 43 lists the OCT calibration block specifications for Stratix V devices.

Table 43. OCT Calibration Block Specifications for Stratix V Devices

| Symbol | Description | Min | Typ | Max | Unit |
|----------------|---|-----|------|-----|--------|
| OCTUSRCLK | Clock required by the OCT calibration blocks | — | — | 20 | MHz |
| T_{OCTCAL} | Number of OCTUSRCLK clock cycles required for OCT R_S/R_T calibration | — | 1000 | — | Cycles |
| $T_{OCTSHIFT}$ | Number of OCTUSRCLK clock cycles required for the OCT code to shift out | — | 32 | — | Cycles |
| T_{RS_RT} | Time required between the <code>dyn_term_ctrl</code> and <code>oe</code> signal transitions in a bidirectional I/O buffer to dynamically switch between OCT R_S and R_T (Figure 10) | — | 2.5 | — | ns |

Figure 10 shows the timing diagram for the `oe` and `dyn_term_ctrl` signals.

Figure 10. Timing Diagram for `oe` and `dyn_term_ctrl` Signals

Duty Cycle Distortion (DCD) Specifications

Table 44 lists the worst-case DCD for Stratix V devices.

Table 44. Worst-Case DCD on Stratix V I/O Pins ⁽¹⁾

| Symbol | C1 | | C2, C2L, I2, I2L | | C3, I3, I3L, I3YY | | C4, I4 | | Unit |
|-------------------|-----|-----|------------------|-----|-------------------|-----|--------|-----|------|
| | Min | Max | Min | Max | Min | Max | Min | Max | |
| Output Duty Cycle | 45 | 55 | 45 | 55 | 45 | 55 | 45 | 55 | % |

Note to Table 44:

(1) The DCD numbers do not cover the core clock network.

Configuration Specification

POR Delay Specification

Power-on reset (POR) delay is defined as the delay between the time when all the power supplies monitored by the POR circuitry reach the minimum recommended operating voltage to the time when the nSTATUS is released high and your device is ready to begin configuration.



For more information about the POR delay, refer to the *Hot Socketing and Power-On Reset in Stratix V Devices* chapter.

Table 45 lists the fast and standard POR delay specification.

Table 45. Fast and Standard POR Delay Specification ⁽¹⁾

| POR Delay | Minimum | Maximum |
|-----------|---------|---------|
| Fast | 4 ms | 12 ms |
| Standard | 100 ms | 300 ms |

Note to Table 45:

(1) You can select the POR delay based on the MSEL settings as described in the MSEL Pin Settings section of the “Configuration, Design Security, and Remote System Upgrades in Stratix V Devices” chapter.

JTAG Configuration Specifications

Table 46 lists the JTAG timing parameters and values for Stratix V devices.

Table 46. JTAG Timing Parameters and Values for Stratix V Devices

| Symbol | Description | Min | Max | Unit |
|-------------------------|------------------------------------|-----|-----|------|
| t _{JCP} | TCK clock period ⁽²⁾ | 30 | — | ns |
| t _{JCP} | TCK clock period ⁽²⁾ | 167 | — | ns |
| t _{JCH} | TCK clock high time ⁽²⁾ | 14 | — | ns |
| t _{JCL} | TCK clock low time ⁽²⁾ | 14 | — | ns |
| t _{JPSU (TDI)} | TDI JTAG port setup time | 2 | — | ns |
| t _{JPSU (TMS)} | TMS JTAG port setup time | 3 | — | ns |

Table 46. JTAG Timing Parameters and Values for Stratix V Devices

| Symbol | Description | Min | Max | Unit |
|------------|--|-----|-------------------|------|
| t_{JPH} | JTAG port hold time | 5 | — | ns |
| t_{JPCO} | JTAG port clock to output | — | 11 ⁽¹⁾ | ns |
| t_{JPZX} | JTAG port high impedance to valid output | — | 14 ⁽¹⁾ | ns |
| t_{JPXZ} | JTAG port valid output to high impedance | — | 14 ⁽¹⁾ | ns |

Notes to Table 46:

- (1) A 1 ns adder is required for each V_{CCIO} voltage step down from 3.0 V. For example, t_{JPCO} = 12 ns if V_{CCIO} of the TDO I/O bank = 2.5 V, or 13 ns if it equals 1.8 V.
- (2) The minimum TCK clock period is 167 ns if VCCBAT is within the range 1.2V-1.5V when you perform the volatile key programming.

Raw Binary File Size

For the POR delay specification, refer to the “POR Delay Specification” section of the “Configuration, Design Security, and Remote System Upgrades in Stratix V Devices”.

Table 47 lists the uncompressed raw binary file (.rbf) sizes for Stratix V devices.

Table 47. Uncompressed .rbf Sizes for Stratix V Devices

| Family | Device | Package | Configuration .rbf Size (bits) | IOCSR .rbf Size (bits) ^{(4), (5)} |
|--------------|--------|------------------------------|--------------------------------|--|
| Stratix V GX | 5SGXA3 | H35, F40, F35 ⁽²⁾ | 213,798,880 | 562,392 |
| | | H29, F35 ⁽³⁾ | 137,598,880 | 564,504 |
| | 5SGXA4 | — | 213,798,880 | 563,672 |
| | 5SGXA5 | — | 269,979,008 | 562,392 |
| | 5SGXA7 | — | 269,979,008 | 562,392 |
| | 5SGXA9 | — | 342,742,976 | 700,888 |
| | 5SGXAB | — | 342,742,976 | 700,888 |
| | 5SGXB5 | — | 270,528,640 | 584,344 |
| | 5SGXB6 | — | 270,528,640 | 584,344 |
| | 5SGXB9 | — | 342,742,976 | 700,888 |
| | 5SGXBB | — | 342,742,976 | 700,888 |
| Stratix V GT | 5SGTC5 | — | 269,979,008 | 562,392 |
| | 5SGTC7 | — | 269,979,008 | 562,392 |
| Stratix V GS | 5SGSD3 | — | 137,598,880 | 564,504 |
| | 5SGSD4 | F1517 | 213,798,880 | 563,672 |
| | | — | 137,598,880 | 564,504 |
| | 5SGSD5 | — | 213,798,880 | 563,672 |
| | 5SGSD6 | — | 293,441,888 | 565,528 |
| | 5SGSD8 | — | 293,441,888 | 565,528 |

Table 50 lists the timing parameters for Stratix V devices for FPP configuration when the DCLK-to-DATA [] ratio is 1.

Table 50. FPP Timing Parameters for Stratix V Devices ⁽¹⁾

| Symbol | Parameter | Minimum | Maximum | Units |
|-----------------------------------|---|--|----------------------|-------|
| t _{CF2CD} | nCONFIG low to CONF_DONE low | — | 600 | ns |
| t _{CF2ST0} | nCONFIG low to nSTATUS low | — | 600 | ns |
| t _{CFG} | nCONFIG low pulse width | 2 | — | μs |
| t _{STATUS} | nSTATUS low pulse width | 268 | 1,506 ⁽²⁾ | μs |
| t _{CF2ST1} | nCONFIG high to nSTATUS high | — | 1,506 ⁽³⁾ | μs |
| t _{CF2CK} ⁽⁶⁾ | nCONFIG high to first rising edge on DCLK | 1,506 | — | μs |
| t _{ST2CK} ⁽⁶⁾ | nSTATUS high to first rising edge of DCLK | 2 | — | μs |
| t _{DSU} | DATA [] setup time before rising edge on DCLK | 5.5 | — | ns |
| t _{DH} | DATA [] hold time after rising edge on DCLK | 0 | — | ns |
| t _{CH} | DCLK high time | $0.45 \times 1/f_{\text{MAX}}$ | — | s |
| t _{CL} | DCLK low time | $0.45 \times 1/f_{\text{MAX}}$ | — | s |
| t _{CLK} | DCLK period | $1/f_{\text{MAX}}$ | — | s |
| f _{MAX} | DCLK frequency (FPP $\times 8/\times 16$) | — | 125 | MHz |
| | DCLK frequency (FPP $\times 32$) | — | 100 | MHz |
| t _{CD2UM} | CONF_DONE high to user mode ⁽⁴⁾ | 175 | 437 | μs |
| t _{CD2CU} | CONF_DONE high to CLKUSR enabled | 4 × maximum DCLK period | — | — |
| t _{CD2UMC} | CONF_DONE high to user mode with CLKUSR option on | t _{CD2CU} + (8576 × CLKUSR period) ⁽⁵⁾ | — | — |

Notes to Table 50:

- (1) Use these timing parameters when the decompression and design security features are disabled.
- (2) This value is applicable if you do not delay configuration by extending the nCONFIG or nSTATUS low pulse width.
- (3) This value is applicable if you do not delay configuration by externally holding the nSTATUS low.
- (4) The minimum and maximum numbers apply only if you chose the internal oscillator as the clock source for initializing the device.
- (5) To enable the CLKUSR pin as the initialization clock source and to obtain the maximum frequency specification on these pins, refer to the Initialization section of the “Configuration, Design Security, and Remote System Upgrades in Stratix V Devices” chapter.
- (6) If nSTATUS is monitored, follow the t_{ST2CK} specification. If nSTATUS is not monitored, follow the t_{CF2CK} specification.

FPP Configuration Timing when DCLK-to-DATA [] > 1

Figure 13 shows the timing waveform for FPP configuration when using a MAX II device, MAX V device, or microprocessor as an external host. This waveform shows timing when the DCLK-to-DATA [] ratio is more than 1.

Table 54 lists the PS configuration timing parameters for Stratix V devices.

Table 54. PS Timing Parameters for Stratix V Devices

| Symbol | Parameter | Minimum | Maximum | Units |
|----------------------------|---|---|----------------------|---------|
| t_{CF2CD} | nCONFIG low to CONF_DONE low | — | 600 | ns |
| t_{CF2ST0} | nCONFIG low to nSTATUS low | — | 600 | ns |
| t_{CFG} | nCONFIG low pulse width | 2 | — | μ s |
| t_{STATUS} | nSTATUS low pulse width | 268 | 1,506 ⁽¹⁾ | μ s |
| t_{CF2ST1} | nCONFIG high to nSTATUS high | — | 1,506 ⁽²⁾ | μ s |
| t_{CF2CK} ⁽⁵⁾ | nCONFIG high to first rising edge on DCLK | 1,506 | — | μ s |
| t_{ST2CK} ⁽⁵⁾ | nSTATUS high to first rising edge of DCLK | 2 | — | μ s |
| t_{DSU} | DATA [] setup time before rising edge on DCLK | 5.5 | — | ns |
| t_{DH} | DATA [] hold time after rising edge on DCLK | 0 | — | ns |
| t_{CH} | DCLK high time | $0.45 \times 1/f_{MAX}$ | — | s |
| t_{CL} | DCLK low time | $0.45 \times 1/f_{MAX}$ | — | s |
| t_{CLK} | DCLK period | $1/f_{MAX}$ | — | s |
| f_{MAX} | DCLK frequency | — | 125 | MHz |
| t_{CD2UM} | CONF_DONE high to user mode ⁽³⁾ | 175 | 437 | μ s |
| t_{CD2CU} | CONF_DONE high to CLKUSR enabled | 4 × maximum DCLK period | — | — |
| t_{CD2UMC} | CONF_DONE high to user mode with CLKUSR option on | $t_{CD2CU} + (8576 \times \text{CLKUSR period})$ ⁽⁴⁾ | — | — |

Notes to Table 54:

- (1) This value is applicable if you do not delay configuration by extending the nCONFIG or nSTATUS low pulse width.
- (2) This value is applicable if you do not delay configuration by externally holding the nSTATUS low.
- (3) The minimum and maximum numbers apply only if you choose the internal oscillator as the clock source for initializing the device.
- (4) To enable the CLKUSR pin as the initialization clock source and to obtain the maximum frequency specification on these pins, refer to the “Initialization” section.
- (5) If nSTATUS is monitored, follow the t_{ST2CK} specification. If nSTATUS is not monitored, follow the t_{CF2CK} specification.

Initialization

Table 55 lists the initialization clock source option, the applicable configuration schemes, and the maximum frequency.

Table 55. Initialization Clock Source Option and the Maximum Frequency

| Initialization Clock Source | Configuration Schemes | Maximum Frequency | Minimum Number of Clock Cycles ⁽¹⁾ |
|-----------------------------|----------------------------|-------------------|---|
| Internal Oscillator | AS, PS, FPP | 12.5 MHz | 8576 |
| CLKUSR | AS, PS, FPP ⁽²⁾ | 125 MHz | |
| DCLK | PS, FPP | 125 MHz | |

Notes to Table 55:

- (1) The minimum number of clock cycles required for device initialization.
- (2) To enable CLKUSR as the initialization clock source, turn on the **Enable user-supplied start-up clock (CLKUSR)** option in the Quartus II software from the **General** panel of the **Device and Pin Options** dialog box.

Table 60. Glossary (Part 2 of 4)

| Letter | Subject | Definitions |
|-----------------------|----------------------------|--|
| G H I | — | — |
| J | JTAG Timing Specifications | <p>High-speed I/O block—Deserialization factor (width of parallel data bus).</p> <p>JTAG Timing Specifications:</p>  |
| K L M N O | — | — |
| P | PLL Specifications | <p>Diagram of PLL Specifications ⁽¹⁾</p>  <p>Note: (1) Core Clock can only be fed by dedicated clock input pins or PLL outputs.</p> |
| Q | — | — |
| R | R _L | Receiver differential input discrete resistor (external to the Stratix V device). |

Table 60. Glossary (Part 4 of 4)

| Letter | Subject | Definitions |
|----------|---------------|--|
| V | $V_{CM(DC)}$ | DC common mode input voltage. |
| | V_{ICM} | Input common mode voltage—The common mode of the differential signal at the receiver. |
| | V_{ID} | Input differential voltage swing—The difference in voltage between the positive and complementary conductors of a differential transmission at the receiver. |
| | $V_{DIF(AC)}$ | AC differential input voltage—Minimum AC input differential voltage required for switching. |
| | $V_{DIF(DC)}$ | DC differential input voltage— Minimum DC input differential voltage required for switching. |
| | V_{IH} | Voltage input high—The minimum positive voltage applied to the input which is accepted by the device as a logic high. |
| | $V_{IH(AC)}$ | High-level AC input voltage |
| | $V_{IH(DC)}$ | High-level DC input voltage |
| | V_{IL} | Voltage input low—The maximum positive voltage applied to the input which is accepted by the device as a logic low. |
| | $V_{IL(AC)}$ | Low-level AC input voltage |
| | $V_{IL(DC)}$ | Low-level DC input voltage |
| | V_{OCM} | Output common mode voltage—The common mode of the differential signal at the transmitter. |
| | V_{OD} | Output differential voltage swing—The difference in voltage between the positive and complementary conductors of a differential transmission at the transmitter. |
| | V_{SWING} | Differential input voltage |
| | V_X | Input differential cross point voltage |
| W | W | High-speed I/O block—clock boost factor |
| X | — | — |
| Y | | |
| Z | | |

Table 61. Document Revision History (Part 2 of 3)

| Date | Version | Changes |
|---------------|---------|--|
| November 2014 | 3.3 | <ul style="list-style-type: none"> ■ Added the I3YY speed grade and changed the data rates for the GX channel in Table 1. ■ Added the I3YY speed grade to the V_{CC} description in Table 6. ■ Added the I3YY speed grade to V_{CCHIP_L}, V_{CCHIP_R}, V_{CCHSSI_L}, and V_{CCHSSI_R} descriptions in Table 7. ■ Added 240-Ω to Table 11. ■ Changed CDR PPM tolerance in Table 23. ■ Added additional max data rate for fPLL in Table 23. ■ Added the I3YY speed grade and changed the data rates for transceiver speed grade 3 in Table 25. ■ Added the I3YY speed grade and changed the data rates for transceiver speed grade 3 in Table 26. ■ Changed CDR PPM tolerance in Table 28. ■ Added additional max data rate for fPLL in Table 28. ■ Changed the mode descriptions for MLAB and M20K in Table 33. ■ Changed the Max value of f_{HCLK_OUT} for the C2, C2L, I2, I2L speed grades in Table 36. ■ Changed the frequency ranges for C1 and C2 in Table 39. ■ Changed the .rbf file sizes for 5SGSD6 and 5SGSD8 in Table 47. ■ Added note about nSTATUS to Table 50, Table 51, Table 54. ■ Changed the available settings in Table 58. ■ Changed the note in “Periphery Performance”. ■ Updated the “I/O Standard Specifications” section. ■ Updated the “Raw Binary File Size” section. ■ Updated the receiver voltage input range in Table 22. ■ Updated the max frequency for the LVDS clock network in Table 36. ■ Updated the DCLK note to Figure 11. ■ Updated Table 23 VO_{CM} (DC Coupled) condition. ■ Updated Table 6 and Table 7. ■ Added the DCLK specification to Table 55. ■ Updated the notes for Table 47. ■ Updated the list of parameters for Table 56. |
| November 2013 | 3.2 | ■ Updated Table 28 |
| November 2013 | 3.1 | ■ Updated Table 33 |
| November 2013 | 3.0 | ■ Updated Table 23 and Table 28 |
| October 2013 | 2.9 | ■ Updated the “Transceiver Characterization” section |
| October 2013 | 2.8 | <ul style="list-style-type: none"> ■ Updated Table 3, Table 12, Table 14, Table 19, Table 20, Table 23, Table 24, Table 28, Table 30, Table 31, Table 32, Table 33, Table 36, Table 39, Table 40, Table 41, Table 42, Table 47, Table 53, Table 58, and Table 59 ■ Added Figure 1 and Figure 3 ■ Added the “Transceiver Characterization” section ■ Removed all “Preliminary” designations. |